

### **NCE P-Channel Super Trench Power MOSFET**

### **Description**

The NCEP40PT13D uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification

### **Application**

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

### **General Features**

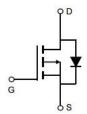
- $V_{DS}$  =-40V, $I_{D}$  =-130A  $R_{DS(ON)}$ =3.85mΩ (typical) @  $V_{GS}$ =-10V  $R_{DS(ON)}$ =5.0mΩ (typical) @  $V_{GS}$ =-4.5V
- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 175 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!

### TO-263-2L







**Schematic Diagram** 

### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP40PT13D	NCEP40PT13D	TO-263-2L	Ø330mm	24mm	800units

### Absolute Maximum Ratings (T<sub>c</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	-40	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I <sub>D</sub>	-130	А
Drain Current-Continuous(T <sub>C</sub> =100 °C)	I <sub>D</sub> (100℃)	-91	А
Pulsed Drain Current	I <sub>DM</sub>	-520	Α
Maximum Power Dissipation	P <sub>D</sub>	220	W
Derating factor		1.47	W/°C
Single pulse avalanche energy (Note 1)	E <sub>AS</sub>	1155	mJ
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 175	$^{\circ}$ C

#### **Thermal Characteristic**

Thermal Resistance,Junction-to-Case	R <sub>θJC</sub>	0.68	°C/W	
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# NCEP40PT13D

## Electrical Characteristics (T<sub>C</sub>=25 ℃ unless otherwise noted)

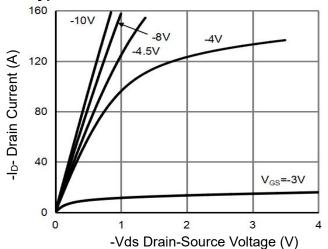
Drain-Source Breakdown Voltage   BV <sub>DSS</sub>   V <sub>GS</sub> =0V I <sub>D</sub> =-250μA   -40	Unit	Max	Тур	Min	Condition	Symbol	Parameter
Zero Gate Voltage Drain Current   IDSS   VDS=-40V, VGS=0V   -   -   1     Gate-Body Leakage Current   IGSS   VGS=±20V, VDS=0V   -   -   ±100     On Characteristics							Off Characteristics
Gate-Body Leakage Current         I <sub>GSS</sub> V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V         -         ±100           On Characteristics           Gate Threshold Voltage         V <sub>GS(III)</sub> V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250µA         -1.0         -1.6         -2.5           Drain-Source On-State Resistance         R <sub>DS(ON)</sub> V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250µA         -         3.85         4.65           Forward Transconductance         grs         V <sub>DS</sub> =-10V, I <sub>D</sub> =-20A         -         5.0         7.5           Forward Transconductance         grs         V <sub>DS</sub> =-5V,I <sub>D</sub> =-20A         -         5.0         7.5           Forward Transconductance         C <sub>ISS</sub> V <sub>DS</sub> =-5V,I <sub>D</sub> =-20A         -         5.0         7.5           Pynamic Characteristics         C <sub>ISS</sub> V <sub>DS</sub> =-20V,V <sub>GS</sub> =0V, F=1.0MHz         -         6100         -           Doutput Capacitance         C <sub>ISS</sub> V <sub>DS</sub> =-20V,V <sub>GS</sub> =0V, F=1.0MHz         -         1500         -           Reverse Transfer Capacitance         C <sub>ISS</sub> V <sub>DS</sub> =-20V,V <sub>GS</sub> =0V, F=1.0MHz         -         1500         -           Switching Characteristics (Note 2)         Turn-on Delay Time         t <sub>I</sub> V <sub>DD</sub> =-20V,I <sub>D</sub> =-20A         -         30         -           Turn-Off Delay Time         t <sub>I</sub> t <sub>I</sub> <	V	-		-40	V <sub>GS</sub> =0V I <sub>D</sub> =-250µA	BV <sub>DSS</sub>	Drain-Source Breakdown Voltage
On Characteristics   On Cha	μΑ	1	-	-	V <sub>DS</sub> =-40V,V <sub>GS</sub> =0V	I <sub>DSS</sub>	Zero Gate Voltage Drain Current
Cate Threshold Voltage   V <sub>GS(th)</sub>   V <sub>DS</sub> =V <sub>GS</sub> ,   <sub>D</sub> =-250µA   -1.0   -1.6   -2.5     Drain-Source On-State Resistance   R <sub>DS(ON)</sub>   V <sub>GS</sub> =-10V,   <sub>D</sub> =-20A   -   3.85   4.65     V <sub>GS</sub> =-4.5V,   <sub>D</sub> =-20A   -   5.0   7.5     Forward Transconductance   g <sub>FS</sub>   V <sub>DS</sub> =-5V,   <sub>D</sub> =-40A   -   50   -     Dynamic Characteristics     Input Capacitance   C <sub>Iss</sub>   V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V,   -   6100   -     Reverse Transfer Capacitance   C <sub>rss</sub>   F=1.0MHz   -   1500   -     Switching Characteristics   (Note 2)     Turn-on Delay Time   t <sub>d(on)</sub>   V <sub>DS</sub> =-20V,   <sub>D</sub> =-20A   -   30   -     Turn-off Delay Time   t <sub>d(off)</sub>   V <sub>GS</sub> =-10V, R <sub>G</sub> =1.6Ω   -   75   -     Turn-Off Fall Time   t <sub>f</sub>   V <sub>DS</sub> =-20V,   <sub>D</sub> =-20A   -   366   -     Total Gate Charge   Q <sub>g</sub>   V <sub>DS</sub> =-20V,   <sub>D</sub> =-20A   -   17.5   -     Gate-Source Charge   Q <sub>g</sub>   V <sub>DS</sub> =-10V   C <sub>SS</sub> =-10V   -   17.5   -     Drain-Source Diode Characteristics   V <sub>SD</sub>   V <sub>SS</sub> =0V,   <sub>S</sub> =-20A   -   17.5   -     Drain-Source Diode Characteristics   V <sub>SD</sub>   V <sub>SS</sub> =0V,   <sub>S</sub> =-20A   -   -   -1.2     Diode Forward Current   I <sub>S</sub>   V <sub>SS</sub> =0V,   <sub>S</sub> =-20A   -   -   -1.30	nA	±100	-	-	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	I <sub>GSS</sub>	Gate-Body Leakage Current
Drain-Source On-State Resistance   R <sub>DS(ON)</sub>   V <sub>GS</sub> =-10V, I <sub>D</sub> =-20A   -   3.85   4.65   V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-20A   -   5.0   7.5							On Characteristics
Drain-Source On-State Resistance   R <sub>DS(ON)</sub>   V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-20A   -   5.0   7.5	V	-2.5	-1.6	-1.0	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250μA	V <sub>GS(th)</sub>	Gate Threshold Voltage
No.   V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-20A   -   5.0   7.5	mΩ	4.65	3.85	- 1	V <sub>GS</sub> =-10V, I <sub>D</sub> =-20A	Б	Dunin Course On State Besietenes
Dynamic Characteristics   Input Capacitance   Class   VDS=-20V, VGS=0V, F=1.0MHz   - 1500	mΩ	7.5	5.0	-	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-20A	RDS(ON)	Drain-Source On-State Resistance
Input Capacitance	S	-	50	-	V <sub>DS</sub> =-5V,I <sub>D</sub> =-40A	<b>g</b> FS	Forward Transconductance
Output Capacitance         Coss         V <sub>DS</sub> =-20V,V <sub>GS</sub> =0V, F=1.0MHz         -         1500         -           Reverse Transfer Capacitance         Crss         -         95         -           Switching Characteristics (Note 2)           Turn-on Delay Time         t <sub>d</sub> (on)         -         13         -           Turn-on Rise Time         t <sub>r</sub> V <sub>DD</sub> =-20V,I <sub>D</sub> =-20A         -         30         -           Turn-Off Delay Time         t <sub>d</sub> (off)         V <sub>GS</sub> =-10V,R <sub>G</sub> =1.6Ω         -         75         -           Turn-Off Fall Time         t <sub>f</sub> -         14         -         -           Total Gate Charge         Q <sub>g</sub> V <sub>DS</sub> =-20V,I <sub>D</sub> =-20A, V <sub>GS</sub> =-10V         -         86         -           Gate-Source Charge         Q <sub>g</sub> V <sub>DS</sub> =-10V         -         17.5         -           Gate-Drain Charge         Q <sub>g</sub> V <sub>GS</sub> =-10V         -         10.5         -           Diode Forward Voltage         V <sub>SD</sub> V <sub>GS</sub> =0V,I <sub>S</sub> =-20A         -         -         -         -           Diode Forward Current         Is         -         -         -         -         -							Dynamic Characteristics
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	PF	-	6100	-	V 00V/V 0V	C <sub>iss</sub>	Input Capacitance
Reverse Transfer Capacitance   Crss   - 95   -	PF	-	1500	-		Coss	Output Capacitance
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	PF	-	95	-	r-1.0IVID2	Crss	Reverse Transfer Capacitance
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$							Switching Characteristics (Note 2)
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	nS	-	13	-		t <sub>d(on)</sub>	Turn-on Delay Time
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	nS	-	30	-	$V_{DD}$ =-20 $V$ , $I_D$ =-20 $A$	t <sub>r</sub>	Turn-on Rise Time
Total Gate Charge         Qg         VDS=-20V, ID=-20A, VGS=-10V         -         86         -           Gate-Source Charge         Qgs         VGS=-10V         -         17.5         -           Gate-Drain Charge         Qgd         -         10.5         -         10.5           Drain-Source Diode Characteristics           Diode Forward Voltage         VSD         VGS=0V, IS=-20A         -         -         -1.2           Diode Forward Current         Is         -         -         -130	nS	-	75	-	$V_{GS}$ =-10 $V$ , $R_{G}$ =1.6 $\Omega$	t <sub>d(off)</sub>	Turn-Off Delay Time
Cate-Source Charge   Qgs   VDS=-20V, ID=-20A, VGS=-10V   - 17.5	nS	-	14	-		t <sub>f</sub>	Turn-Off Fall Time
Gate-Source Charge         Qgs         VGS=-10V         -         17.5         -         17.5         -         10.5         -         10.5         -         -         10.5         -	nC	-	86	-	V 00VI 00A	Qg	Total Gate Charge
Gate-Drain Charge         Qgd         -         10.5           Drain-Source Diode Characteristics           Diode Forward Voltage         VsD         Vgs=0V,ls=-20A         -         -1.2           Diode Forward Current         Is         -         -         -130	nC		17.5	-		Q <sub>gs</sub>	Gate-Source Charge
Diode Forward Voltage         V <sub>SD</sub> V <sub>GS</sub> =0V,I <sub>S</sub> =-20A         -         -1.2           Diode Forward Current         Is         -         -         -130	nC		10.5	-	V <sub>GS</sub> =-10V	$Q_{gd}$	Gate-Drain Charge
Diode Forward Current Is130							Drain-Source Diode Characteristics
	V	-1.2		-	V <sub>GS</sub> =0V,I <sub>S</sub> =-20A	V <sub>SD</sub>	Diode Forward Voltage
Reverse Recovery Time $t_{rr}$ $T_{\perp} = 25^{\circ}\text{C}$ . $I_{\text{F}} = -65\text{A}$ - 55 -	Α	-130	-	-		Is	Diode Forward Current
, , , , , , , , , , , , , , , , , , , ,	nS	-	55	-	T <sub>J</sub> = 25°C, I <sub>F</sub> =-65A	t <sub>rr</sub>	Reverse Recovery Time
Reverse Recovery Charge Qrr di/dt = 100A/µs - 75 -	nC	-	75	-	di/dt = 100A/µs	Qrr	Reverse Recovery Charge

### Notes:

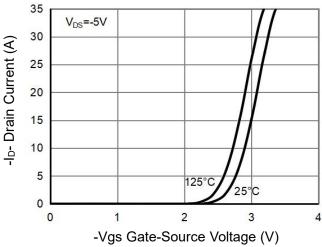
- 1. EAS condition : Tj=25  $^{\circ}\text{C}$  ,VDD=-20V,VG=-10V,L=0.5mH,Rg=25 $\Omega$
- 2. Guaranteed by design, not subject to production
- 3. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T<sub>J(MAX)</sub>=175°C. The SOA curve provides a single pulse rating.



### **Typical Electrical and Thermal Characteristics**



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

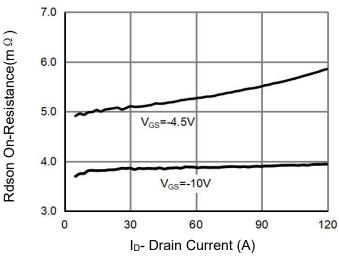


Figure 3 Rdson- Drain Current

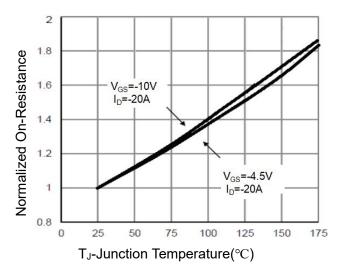
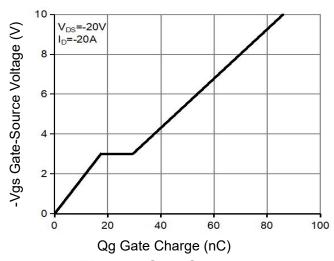


Figure 4 Rdson-JunctionTemperature



**Figure 5 Gate Charge** 

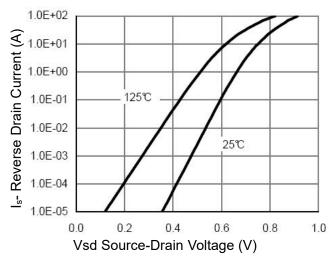


Figure 6 Source- Drain Diode Forward



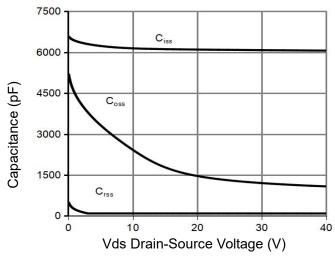


Figure 7 Capacitance vs Vds

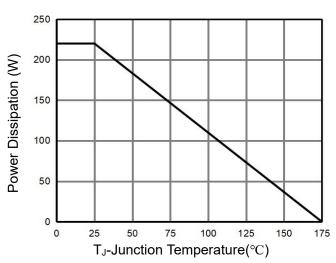


Figure 9 Power De-rating

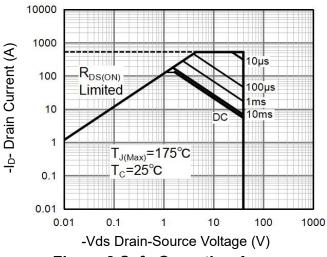


Figure 8 Safe Operation Area(Note3)

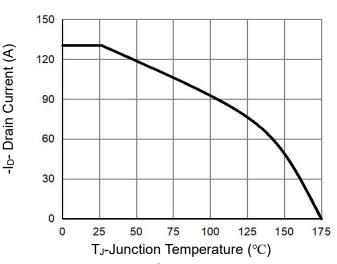


Figure 10 Current De-rating

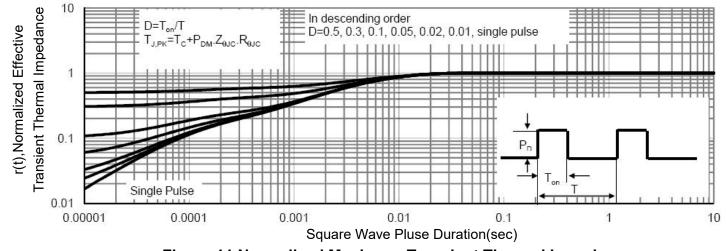
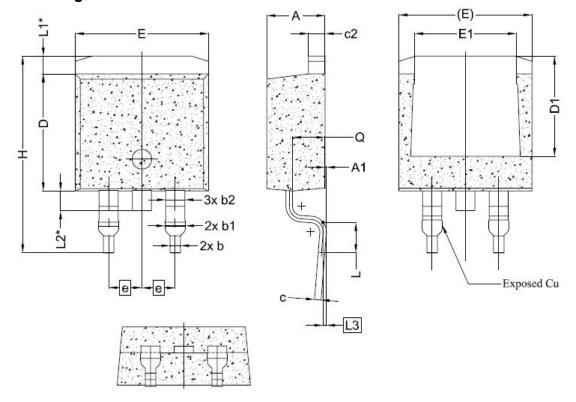


Figure 11 Normalized Maximum Transient Thermal Impedance



# **TO-263-2L Package Information**



SYMBOL	1	DIMENSIONS	S
SYMBOL	MIN.	NOM.	MAX.
Α	4.24	4.44	4.64
A1	0.00	0.10	0.15
b	0.70	0.80	0.90
b1	1,20	1.55	1,75
b2	1,20	1,45	1,70
С	0.40	0.50	0.60
c2	1,15	1,27	1,40
D	8.82	8.92	9.02
D1	6.86	7.65	2) Y-22
E	9,96	10.16	10,36
E1	6,89	7.77	7.89
е		2,54 BSC	
Н	14,61	15,00	15,88
L	1.78	2.32	2.79
L1		1.36 REF.	
L2	1.50 REF. 0.25 BSC		
L3			
Q	2,30	2.48	2.70

### http://www.ncepower.com

# NCEP40PT13D

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